



# BC68PAS-Q series

20 V, 2 A NPN medium power transistors

Rev. 1 — 13 December 2024

Product data sheet

## 1. General description

NPN medium power transistors in an ultra thin DFN2020D-3 (SOT1061D) leadless small Surface-Mounted Device (SMD) plastic package with medium power capability and visible and solderable side pads.

PNP complement: BC69PAS-Q series

## 2. Features and benefits

- High collector current capability  $I_C$  and  $I_{CM}$
- Two current gain selections
- Reduced Printed-Circuit Board (PCB) area requirements
- Leadless very small SMD plastic package with medium power capability
- Exposed heatsink for excellent thermal and electrical conductivity
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- Linear voltage regulators
- Low-side switches
- Battery-driven devices
- Power management
- MOSFET drivers
- Amplifiers

## 4. Quick reference data

Table 1. Quick reference data

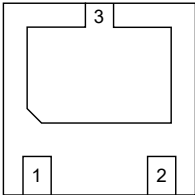
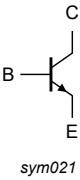
$T_{amb} = 25\text{ °C}$  unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base		-	-	20	V
$I_C$	collector current			-	-	2	A
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1\text{ ms}$		-	-	3	A
$h_{FE}$	DC current gain						
	BC68PAS-Q	$V_{CE} = 1\text{ V}$ ; $I_C = 500\text{ mA}$	[1]	85	-	375	
	BC68-25PAS-Q		[1]	160	-	375	

[1] pulsed;  $t_p \leq 300\text{ }\mu\text{s}$ ;  $\delta \leq 0.02$

5. Pinning information

Table 2. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base	 Transparent top view	 sym021
2	E	emitter		
3	C	collector		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
<a href="#">BC68PAS-Q</a>	DFN2020D-3	lastic, leadless thermal enhanced ultra thin small outline package with side-wettable flanks (SWF); no leads; 3 terminals; 1.3 mm pitch; body: 2 x 2 x 0.65 mm	<a href="#">SOT1061D</a>
<a href="#">BC68-25PAS-Q</a>			

7. Marking

Table 4. Marking

Type number	Marking code
BC68PAS-Q	BY
BC68-25PAS-Q	BZ

8. Limiting values

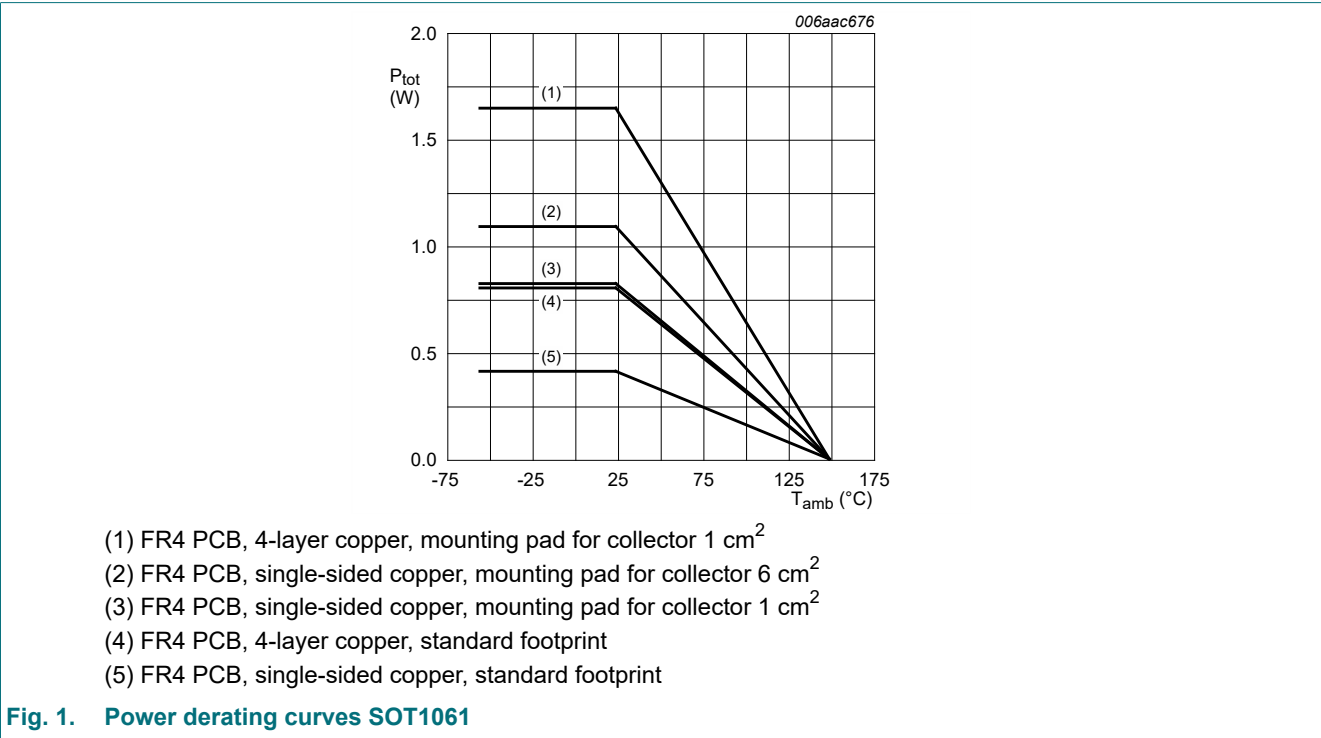
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

T<sub>amb</sub> = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter	-	32	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	20	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	5	V
I <sub>C</sub>	collector current		-	2	A
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms	-	3	A
I <sub>B</sub>	base current		-	0.4	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	420 mW
			[2]	-	830 mW
			[3]	-	1.10 W
			[4]	-	810 mW
			[5]	-	1.65 W
T <sub>j</sub>	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	150	°C
T <sub>stg</sub>	storage temperature		-65	150	°C

- [1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
- [3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
- [4] Device mounted on an FR4 PCB; 4-layer copper; tin-plated and standard footprint.
- [5] Device mounted on an FR4 PCB; 4-layer copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.



9. Thermal characteristics

Table 6. Thermal characteristics  
 $T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	298	K/W
			[2]	-	-	151	K/W
			[3]	-	-	114	K/W
			[4]	-	-	154	K/W
			[5]	-	-	76	K/W
$R_{(j-sp)}$	thermal resistance from junction to solder point			-	-	20	K/W

- [1] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.  
[2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.  
[3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.  
[4] Device mounted on an FR4 PCB; 4-layer copper; tin-plated and standard footprint.  
[5] Device mounted on an FR4 PCB; 4-layer copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.

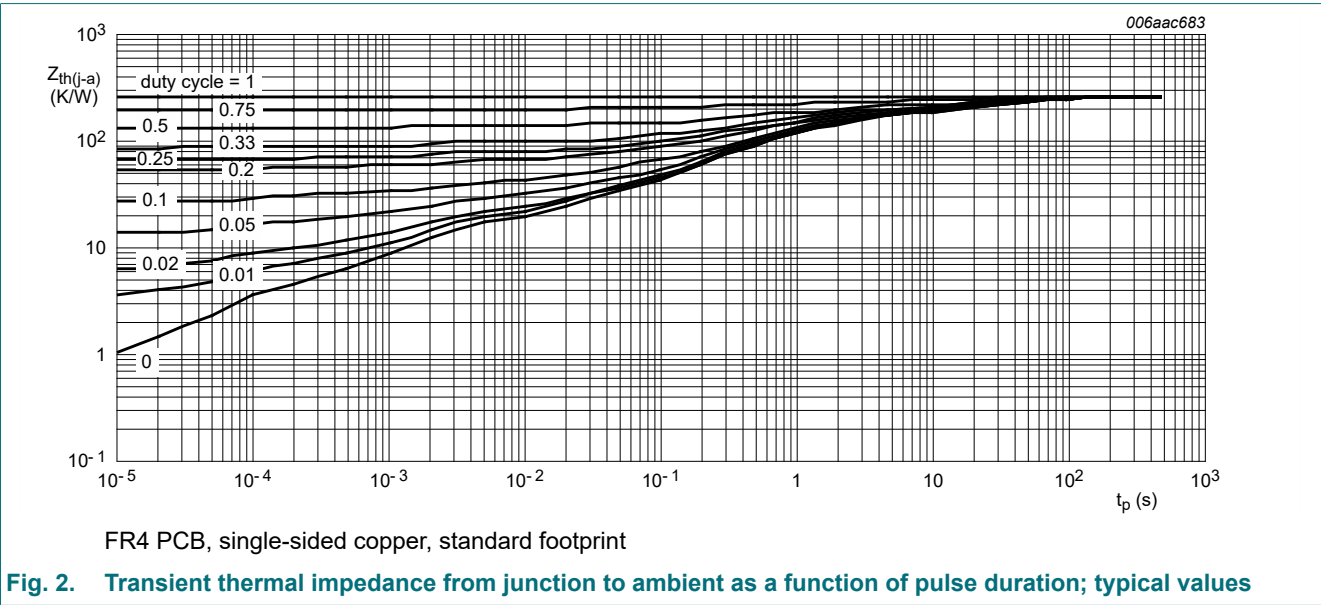
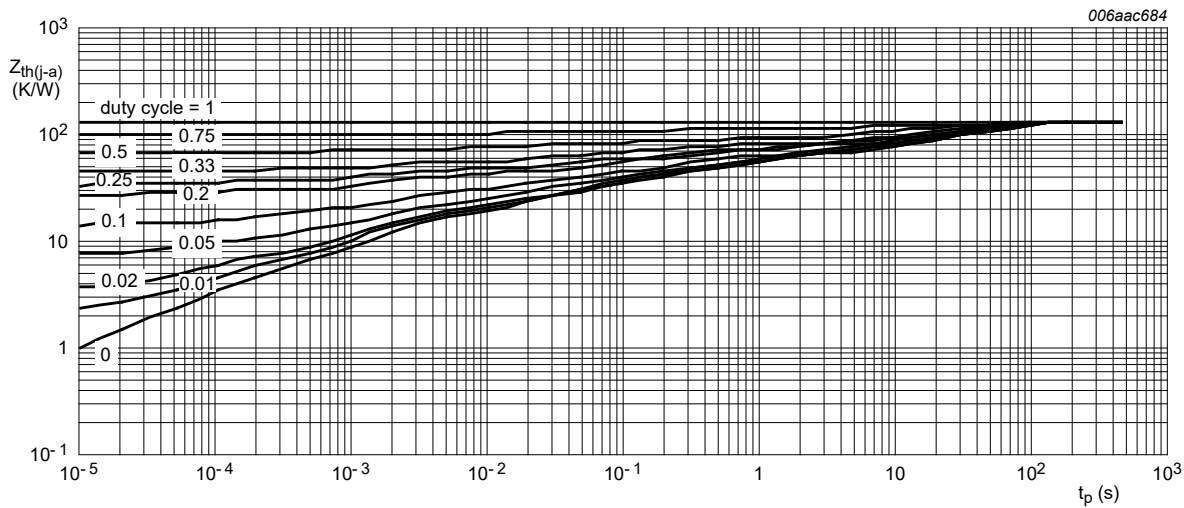
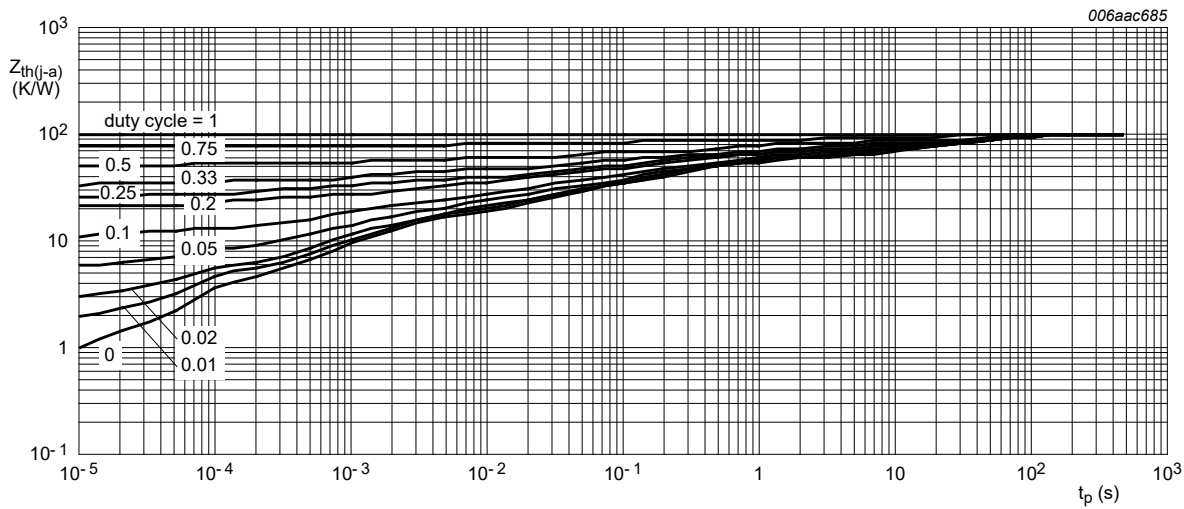


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



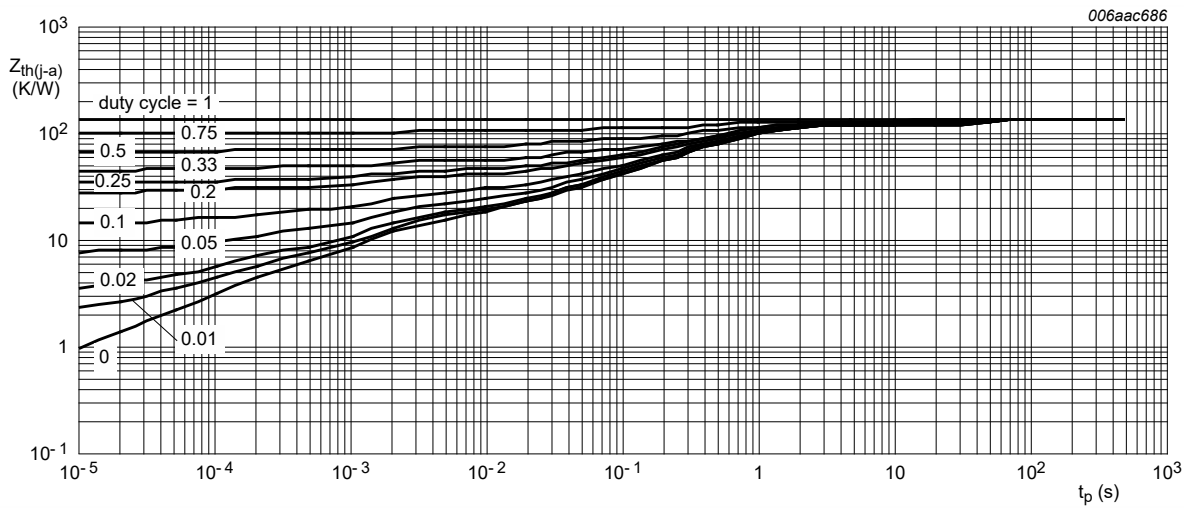
FR4 PCB, single-sided copper, mounting pad for collector 1 cm<sup>2</sup>

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



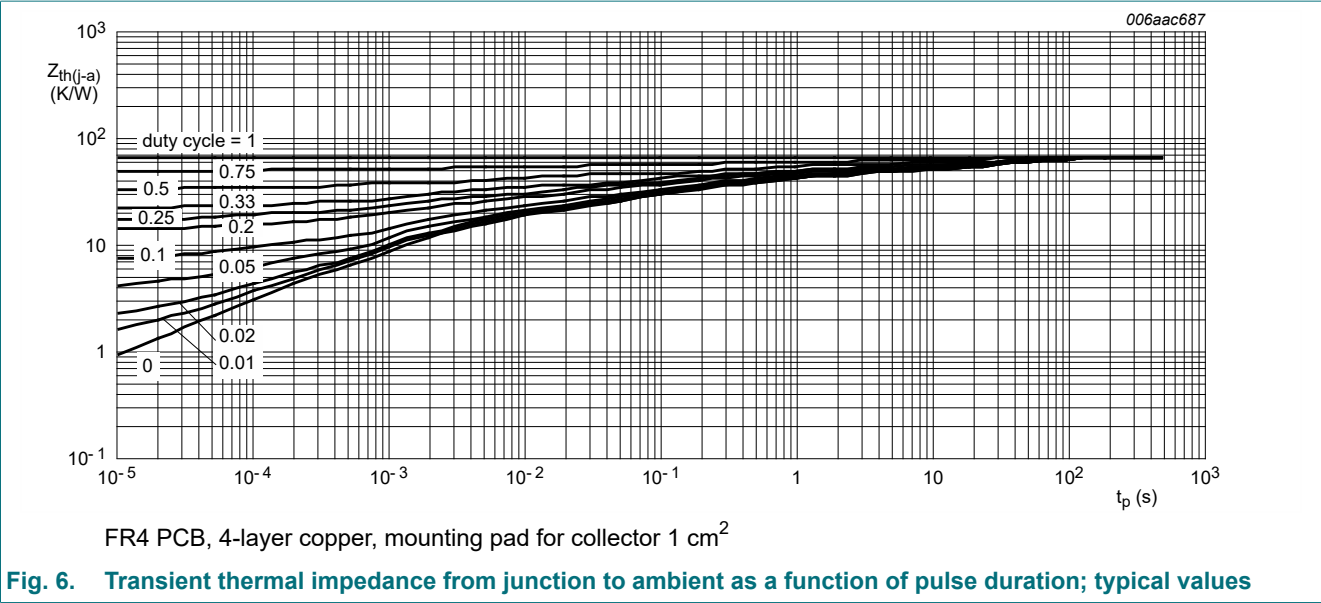
FR4 PCB, single-sided copper, mounting pad for collector 6 cm<sup>2</sup>

Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, 4-layer copper, standard footprint

Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

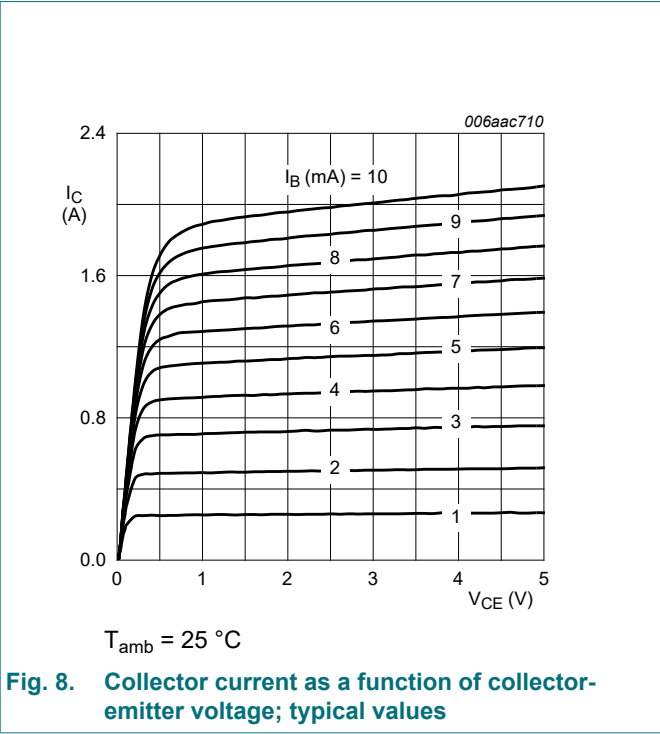
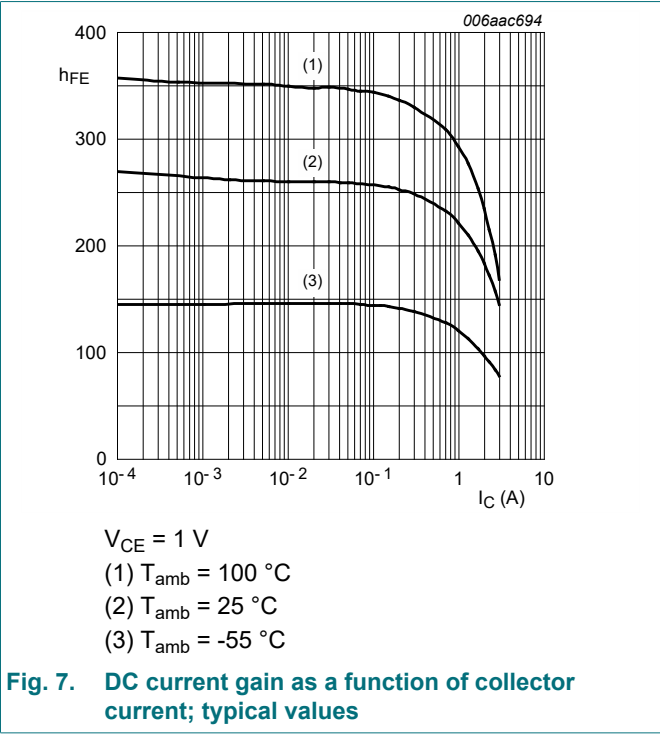


10. Characteristics

Table 7. Characteristics  
*T<sub>amb</sub> = 25 °C unless otherwise specified.*

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = 25 V; I <sub>E</sub> = 0 A		-	-	100	nA
		V <sub>CB</sub> = 25 V; I <sub>E</sub> = 0 A; T <sub>J</sub> = 150 °C		-	-	10	μA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0 A		-	-	100	nA
h <sub>FE</sub>	DC current gain						
	BC68PAS-Q	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 5 mA	[1]	50	-	-	
		V <sub>CE</sub> = 1 V; I <sub>C</sub> = 500 mA	[1]	85	-	375	
		V <sub>CE</sub> = 1 V; I <sub>C</sub> = 1 A	[1]	60	-	-	
		V <sub>CE</sub> = 1 V; I <sub>C</sub> = 2 A	[1]	40	-	-	
	BC68-25PAS-Q	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 5 mA	[1]	50	-	-	
		V <sub>CE</sub> = 1 V; I <sub>C</sub> = 500 mA	[1]	160	-	375	
		V <sub>CE</sub> = 1 V; I <sub>C</sub> = 1 A	[1]	60	-	-	
		V <sub>CE</sub> = 1 V; I <sub>C</sub> = 2 A	[1]	40	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA	[1]	-	-	0.5	V
		I <sub>C</sub> = 2 A; I <sub>B</sub> = 200 mA	[1]	-	-	0.6	V
V <sub>BE</sub>	base-emitter voltage	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 5 mA	[1]	-	-	0.7	V
		V <sub>CE</sub> = 1 V; I <sub>C</sub> = 1 A	[1]	-	-	1	V
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = 10 V; I <sub>E</sub> = i <sub>e</sub> = 0 A; f = 1 MHz		-	22	-	pF
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 50 mA; f = 100 MHz		40	170	-	MHz

[1] pulsed; t<sub>p</sub> ≤ 300 μs; δ ≤ 0.02



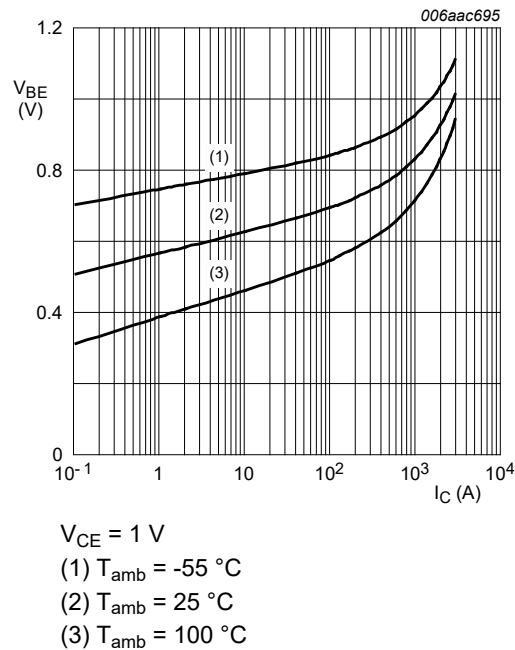


Fig. 9. Base-emitter voltage as a function of collector current; typical values

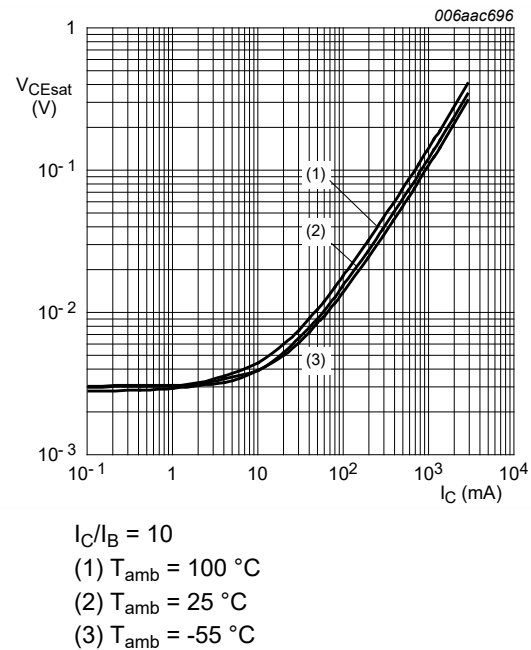


Fig. 10. Collector-emitter saturation voltage as a function of collector current; typical values

11. Test information

11.1. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

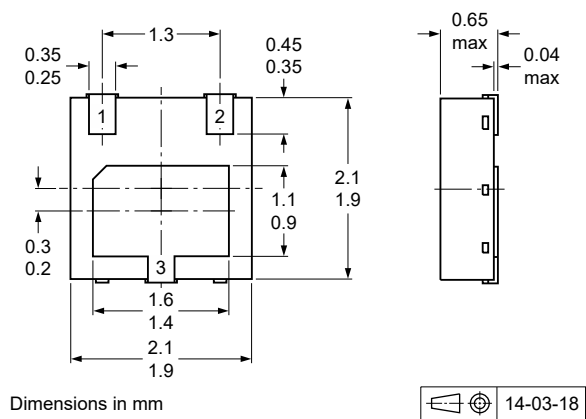


Fig. 11. Package outline DFN2020D-3 (SOT1061D)



13. Soldering

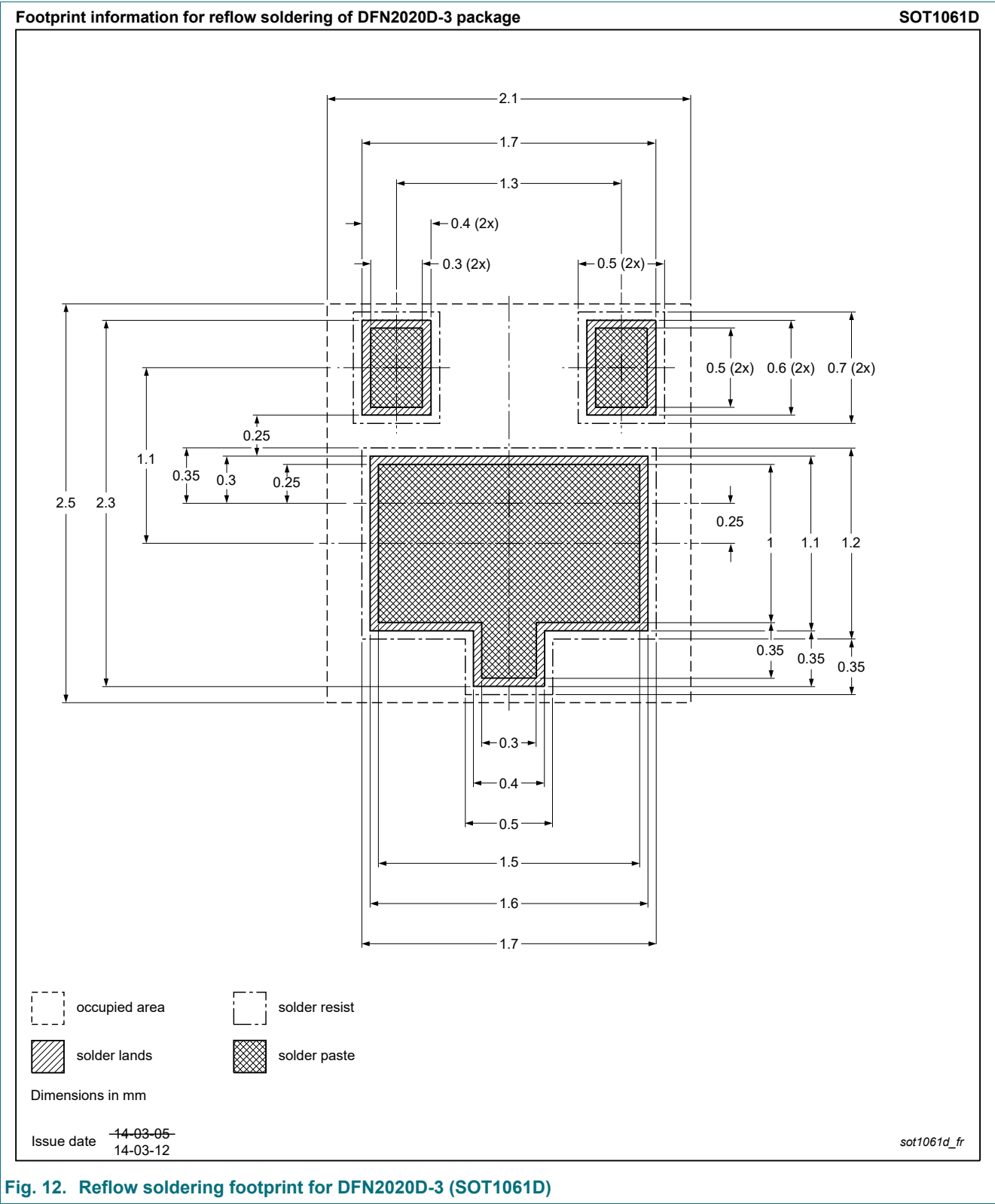


Fig. 12. Reflow soldering footprint for DFN2020D-3 (SOT1061D)

14. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BC68PAS-Q_SER v.1	20241213	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Contents

1. General description..... 1

2. Features and benefits..... 1

3. Applications..... 1

4. Quick reference data..... 1

5. Pinning information.....2

6. Ordering information.....2

7. Marking.....2

8. Limiting values..... 3

9. Thermal characteristics..... 4

10. Characteristics..... 7

11. Test information..... 8

11.1. Quality information..... 8

12. Package outline..... 8

13. Soldering..... 9

14. Revision history.....10

15. Legal information.....11

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